

### **DATASHEET**

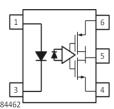
# 5 PIN SOP 3.3V HIGH SPEED 15MBit/s LOGIC GATE PHOTOCOUPLER ELM8XL-G Series



#### **Features**

- •Compliance Halogen Free (Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)
- 3.3 and 5 V CMOS compatibility, Logic gate output
- Guaranteed performance from -40 to 85<sup>°</sup>C
- High isolation voltage between input and output (Viso=3750 V rms)
- Compliance with EU REACH
- Pb free and RoHS compliant
- UL and cUL approved
- VDE approved
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

#### **Schematic**



#### Pin Configuration

- 1: Anode
- 3: Cathode
- 4: GND
- 5: V<sub>out</sub>
- 6: V<sub>CC</sub>

#### **Description**

The ELM8XL consists of an infrared emitting diode optically coupled to a CMOS detector ICs. It is packaged in a 5-pin SOP package and is suitable for surface mounting technology.

#### **Applications**

- Line receiver, data transmission
- Data multiplexing
- Switching power supplies
- Pulse transformer replacement
- Computer peripheral interface
- High speed logic ground isolation

#### **Truth Table (Positive Logic)**

Input	Output
Н	L
L	Н



#### Absolute Maximum Ratings (T<sub>A</sub>=25°C)

	Parameter	Symbol	Rating	Unit
	Forward current	lf	15	mA
Input	Reverse voltage	V <sub>R</sub>	5	V
	Power dissipation	P <sub>D</sub>	35	mW
	Power dissipation	Po	85	mW
Output	Output current	lo	20	mA
	Supply voltage	Vcc	5.5	V
Total Pow	er Dissipation	P <sub>T</sub>	100	mW
Isolation v	oltage *2	V <sub>ISO</sub>	3750	V rms
Operating	temperature	T <sub>OPR</sub>	-40 ~ +85	°C
Storage te	emperature	T <sub>STG</sub>	-55 ~ +125	°C
Soldering	temperature *3	T <sub>SOL</sub>	260	°C

#### Notes:

<sup>\*1</sup> The V<sub>CC</sub> supply must be bypassed by a 0.1µF capacitor or larger. This can be either a ceramic or solid tantalum capacitor with good high frequency characteristic and should be connected as close as possible to the package V<sub>CC</sub> and GND pins

<sup>\*2</sup> AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

<sup>\*3</sup> For 10 seconds



#### **Electrical Characteristics**

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	$V_{F}$	-	1.4	1.8	V	$I_F = 8mA$
Reverse voltage	$V_{R}$	5.0	-	-	V	I <sub>R</sub> = 10μA
Temperature coefficient of forward voltage	$\Delta V_F/\Delta T_A$	-	-1.7	-	mV/°C	I <sub>F</sub> =8mA
Input capacitance	C <sub>IN</sub>	-	60	-	pF	V <sub>F</sub> =0, f=1MHz

Output						
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
High level supply current	Іссн	-	1.3	6	mA	I <sub>F</sub> =0mA
Low level supply current	I <sub>CCL</sub>	-	1.3	6	mA	I <sub>F</sub> =8mA
High level output voltage	Vон -	V <sub>CC</sub> -1	V <sub>CC</sub> -0.3	Tre	V	V <sub>CC</sub> =3.3V, I <sub>F</sub> =0mA, I <sub>O</sub> =-4mA
		V <sub>CC</sub> -1	V <sub>CC</sub> -0.2		V	V <sub>CC</sub> =5V I <sub>F</sub> =0mA, I <sub>O</sub> =-4mA
Low level output voltage	Vol -		0.21	0.6	V	Vcc = 3.3V, I <sub>F</sub> =8mA, I <sub>O</sub> =4mA
Low level output voltage			0.17	0.6	V	V <sub>CC</sub> = 5.0V, I <sub>F</sub> =8mA, I <sub>O</sub> =4mA
Input threshold current	lft	-	2	5	mA	Vcc = 3.3V, lo∟=20uA

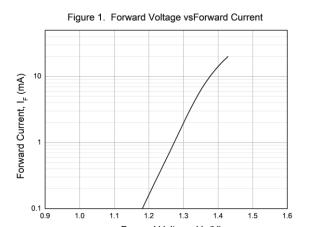


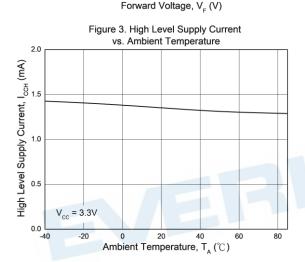
#### **Switching Characteristics**

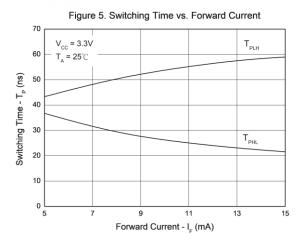
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Propagation delay time	4	-	30	65	ns	I=8mA, Vcc=3.3V
to output high level	t <sub>PHL</sub>	-	33		ns	I <sub>F</sub> =8mA, V <sub>CC</sub> =5V
Propagation delay time	tргн	-	48	65	ns	I <sub>F</sub> =8mA, V <sub>CC</sub> =3.3V
to output low level	IPLH		52		ns	I <sub>F</sub> =8mA, V <sub>CC</sub> =5V
Pulse width distortion	Itom tom		20	50	ns	I <sub>F</sub> =8mA, V <sub>CC</sub> =3.3V
r uise wiutii uistoitioii	tphl — tplh		22		ns	I <sub>F</sub> =8mA, V <sub>CC</sub> =5V
Output rise time	t <sub>r</sub>	-	7	-	ns	I <sub>F</sub> =8mA , V <sub>CC</sub> =3.3V
Output fall time	t <sub>f</sub>	-	7	-	ns	IF=6IIIA, VCC=3.3V
Common M80L	CM <sub>H</sub>	5,000	- 1	TE	V/µS	I <sub>F</sub> = 0mA , T <sub>A</sub> =25°C V <sub>CM</sub> =1000Vp-p
transient Immunity at M81L logic high*4		10,000			V/µS	$I_F = 0$ mA , $T_A = 25$ °C $V_{CM} = 1000$ Vp-p
Common M80L transient	ICM	5,000	-	-	V/µS	$I_F = 8mA$ , $T_A=25$ °C $V_{CM}=1000Vp-p$
immunity at logic low*5	-  CM <sub>L</sub>	10,000			V/µS	$I_F = 8mA , T_A = 25^{\circ}C$ $V_{CM} = 1000Vp-p$

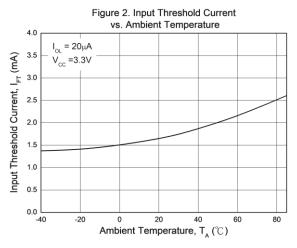


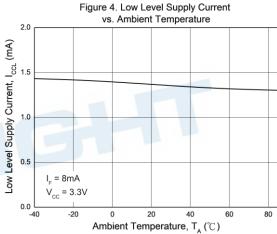
#### **Typical Electro-Optical Characteristics Curves**











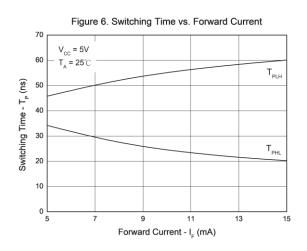


Figure 7. Test circuit and waveforms for tPHL, tPLH, tr, and tf

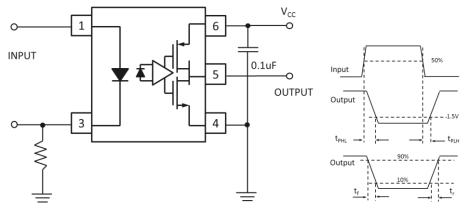
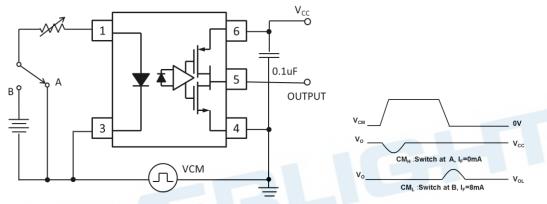


Figure 8. Test circuit Common mode Transient Immunity



#### Note:

<sup>\*4.</sup> CM<sub>H</sub>- The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the HIGH state (i.e.,  $V_{OUT} > 2.0V$ ).

<sup>\*5.</sup> CML— The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the LOW output state (i.e., Vout < 0.8V).



#### **Order Information**

#### **Part Number**

# ELM8XL(Z)-V

#### Note

M8XL = Part No

Z = Tape and reel option (TA, TB or none).

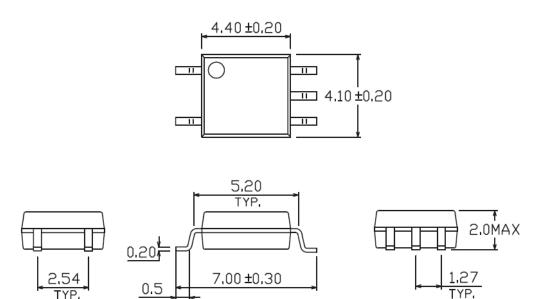
V = VDE (optional)

Option	Description	Packing quantity	
None	Standard SMD option	100 units per tube	
(TA)	Surface mount lead form + TA tape & reel option	3000 units per reel	
(TB)	Surface mount lead form + TB tape & reel option	3000 units per reel	

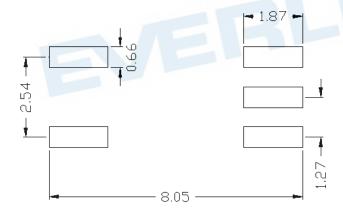




# Package Dimension (Dimensions in mm)



#### Recommended pad layout for surface mount leadform



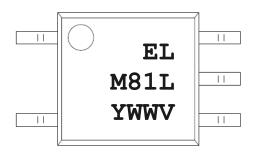
Notes.

Suggested pad dimension is just for reference only.

Please modify the pad dimension based on individual need.



#### **Device Marking**



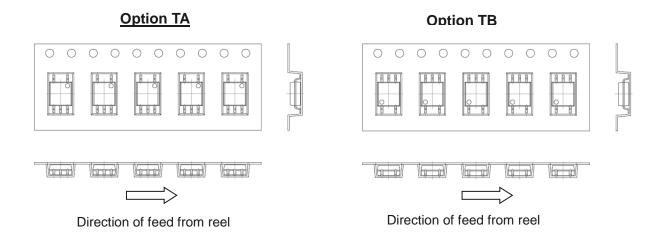
#### **Notes**

EL	denotes EVERLIGHT
M81L	denotes Device Number
Υ	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

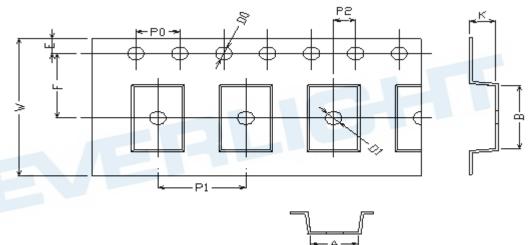




**Tape & Reel Packing Specifications** 



#### **Tape dimension**



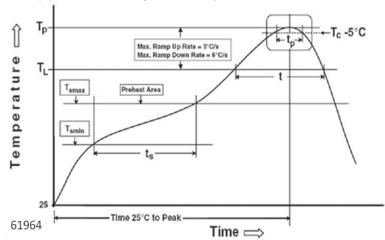
Dimension No.	Α	В	D0	D1	E	F
Dimension (mm)	4.4±0.1	7.6±0.1	1.5±0.1	1.5±0.1	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	w	К
Dimension (mm)	4.0±0.15	8.0±0.1	2.0±0.1	0.3±0.1	16.0±0.2	2.4±0.1



#### **Precautions for Use**

#### 1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

#### **Preheat**

Temperature min  $(T_{smin})$  150 °C Temperature max  $(T_{smax})$  200 °C

Time  $(T_{smin} \text{ to } T_{smax})$   $(t_s)$  60-120 seconds Average ramp-up rate  $(T_{smax} \text{ to } T_p)$  3 °C/second max

#### Other

Liquidus Temperature (T<sub>L</sub>)

Time above Liquidus Temperature (t L)

Peak Temperature (T<sub>P</sub>)

Time within 5 °C of Actual Peak Temperature: TP - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

217 °C

60-100 sec

260°C

30 s

6°C /second max.

8 minutes max.

3 times



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